TOSHIBA PHOTO-INTERRUPTER INFRARED LED + PHOTOTRANSISTOR

TLP818

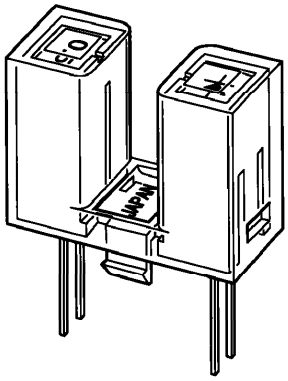
BURNER MOTOR ROTATION DETECTOR FOR OIL FAN HEATERS

COIN PASS DETECTOR FOR VENDING MACHINES

PAPER PASS DETECTOR FOR TICKET VENDING MACHINES

PAPER DETECTOR FOR PRINTERS AND FAX MACHINES

The TLP818 is a photo-interrupter with a dust-proof cover. It is not particularly prone to the adverse effects of dust since dust does not accumulate in the detection.



TOSHIBA

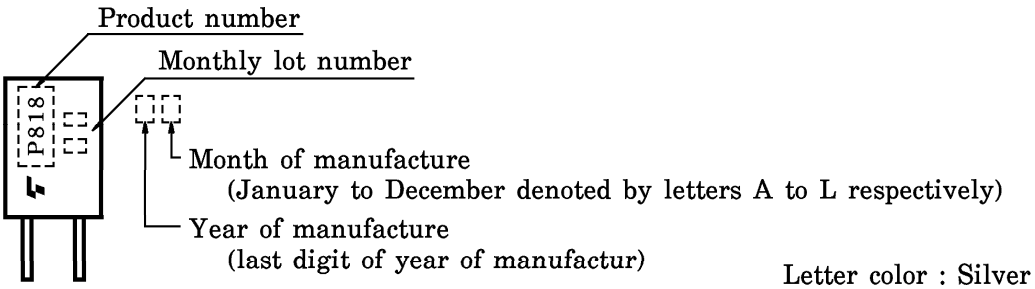
Weight : 1.29 g (typ.)

- Built-in dust-proof cover
- Snap-in mounting type (for 1.6 mm thick of PCBs)
- Gap : 5 mm
- Resolution : Slit width = 0.5 mm
- High current transfer ratio : I_C / I_F = 2.5% (min)
- Fast response speed : t_r, t_f = 6 μs (typ.)
- Device is not adversely affected by indoor lighting because detector is made of resin which is impermeable to visible light.
- Package material : Polycarbonate

MAXIMUM RATINGS (Ta = 25°C)

	CHARACTERISTIC	SYMBOL	RATING	UNIT
LED	Forward Current	I_F	50	mA
	Forward Current Derating (Ta > 25°C)	ΔI_F / °C	−0.33	mA / °C
	Reverse Voltage	V_R	5	V
DETECTOR	Collector-Emitter Voltage	V_{CEO}	35	V
	Emitter Collector Voltage	V_{ECO}	5	V
	Collector Power Dissipation	P_C	75	mW
	Collector Power Dissipation Derating (Ta > 25°C)	ΔP_C / °C	−1	mW / °C
	Collector Current	I_C	50	mA
Operating Temperature Range		T_{opr}	−25~85	°C
Storage Temperature		T_{stg}	−40~100	°C

MARKINGS



Letter color : Silver

OPTICAL AND ELECTRICAL CHARACTERISTICS (Ta = 25°C)

	CHARACTERISTIC	SYMBOL	TEST CONDITION	Min	Typ.	Max	UNIT
LED	Forward Voltage	V_F	I_F = 10 mA	1.00	1.15	1.30	V
LED	Reverse Current	I_R	V_R = 5 V	—	—	10	μA
LED	Peak Light Emission Wavelength	λ_P	I_F = 10 mA	—	940	—	nm
DETECTOR	Dark Current	I_D (I_{CEO})	V_{CE} = 24 V, I_F = 0	—	—	0.1	μA
DETECTOR	Peak Sensitivity Wavelength	λ_P	—	—	870	—	nm
COUPLED	Current Transfer Ratio	I_C / I_F	V_{CE} = 5 V, I_F = 20 mA	2.5	—	32	%
COUPLED	Leakage Current	I_{LEAK}	V_{CE} = 5 V, I_F = 50 mA Shutter in	—	—	10	μA
COUPLED	Collector-Emitter Saturation Voltage	$V_{CE\ (sat)}$	I_F = 20 mA, I_C = 0.25 mA	—	0.15	0.4	V
COUPLED	Rise Time	t_r	V_{CC} = 5 V, I_C = 2 mA, R_L = 100 kΩ	—	6	—	μs
COUPLED	Fall Time	t_f		—	6	—	μs

PRECAUTIONS

The following points must be borne in mind.

1. Soldering temperature : 260°C max
   Soldering time : 5 s max
   (Soldering must be performed 1.5 mm under the package body.)
2. Clean only the soldered part of the leads. Do not immerse the entire package in the cleaning solvent.
3. The package is made of polycarbonate. Polycarbonate is usually stable with acid, alcohol and aliphatic hydrocarbons, however, with petrochemicals (such as benzene, toluene and acetone), alkalis, aromatic hydrocarbons, or chloric hydrocarbons, polycarbonate may crack, swell or melt. Please take this into account when chosing a packaging material by refering to the table below.

<Chemicals which should not be used with polycarbonate>

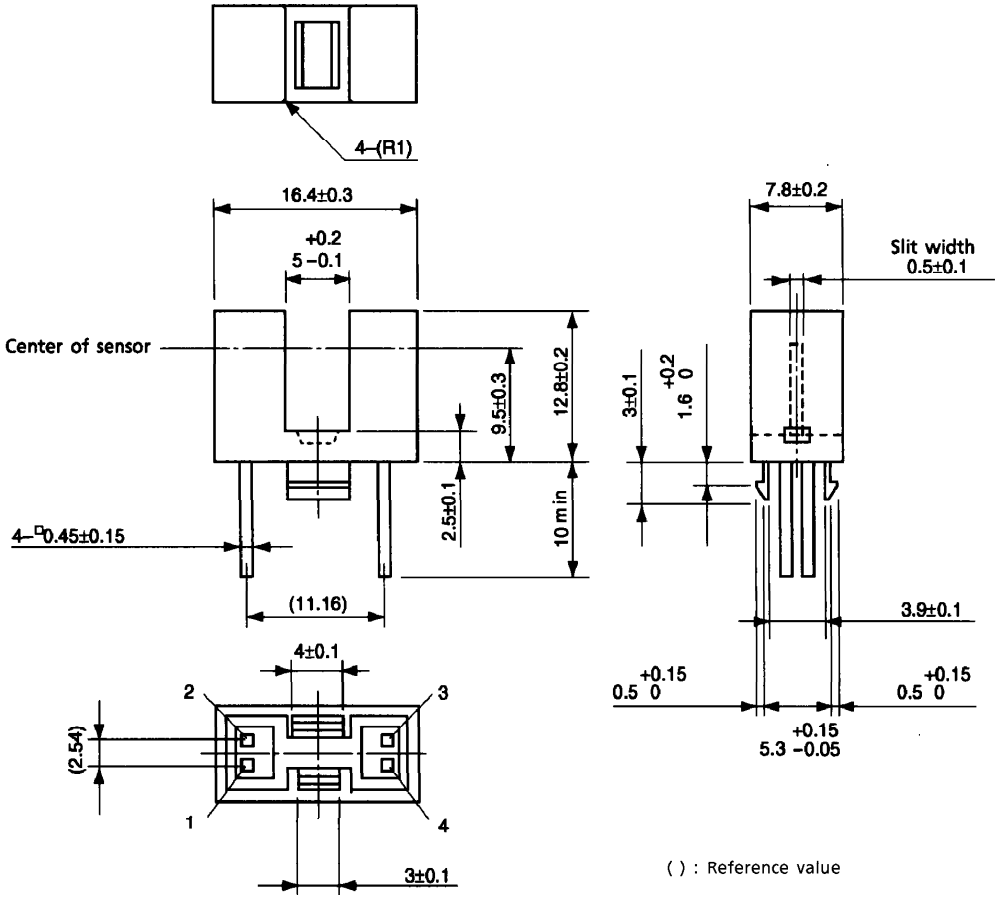
	PHENOMENON	CHEMICALS
A	Staining and slight deterioration	• Nitric acid (diluted), hydrogen peroxide, chlorine
B	Cracking, crazed or swelling	• Acetic acid (70% or more) • Gasoline • Methyl ethyl ketone, ethyl acetate, butyl acetate • Ethyl methacrylate, ethyl ether, MEK • Acetone, m-amino alcohol, carbon tetrachloride • Carbon disulfide, trichloroethylene, cresol • Thinners, oil of turpentine • Triethanolamine, TCP, TBP
C	Melting { } : Used as solvent	• Concentrated sulfuric acid • Benzene • Styrene, acrylonitrile, vinyl acetate • Ethylenediamine, diethylenediamine • {Chloroform, methyl chloride, tetrachloromethane, dioxane, 1, 2-dichloroethane}
D	Decomposition	• Ammonia water • Other alkalis

4. Mount the device on a level surface.
5. This product has a dust-proof cover over the detection slit but does not have one on the underside.
6. Conversion efficiency falls over time due to the current which flows in the infrared LED.
   When designing a circuit, take into account this change in conversion efficiency over time.
   The ratio of fluctuation in conversion efficiency to fluctuation in infrared LED optical output is 1 : 1.

$$\frac{I_C / I_F (t)}{I_C / I_F (0)} = \frac{P_O (t)}{P_O (0)}$$

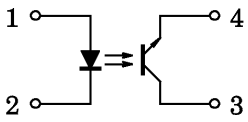
PACKAGE DIMENSIONS

Unit : mm



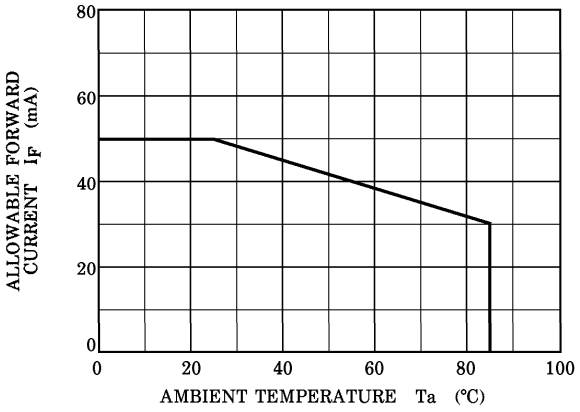
Weight : 1.29 g (typ.)

PIN CONNECTION

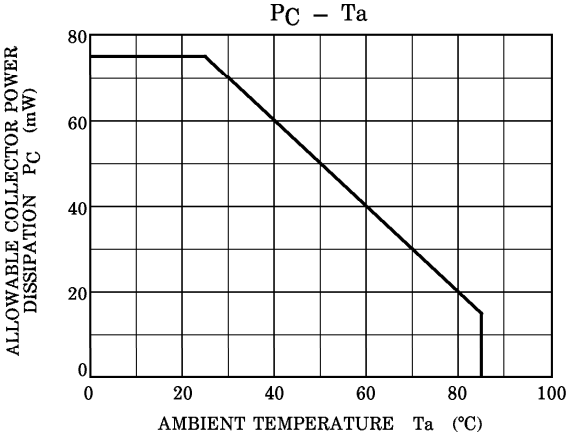


1. Anode
2. Cathode
3. Collector
4. Emitter

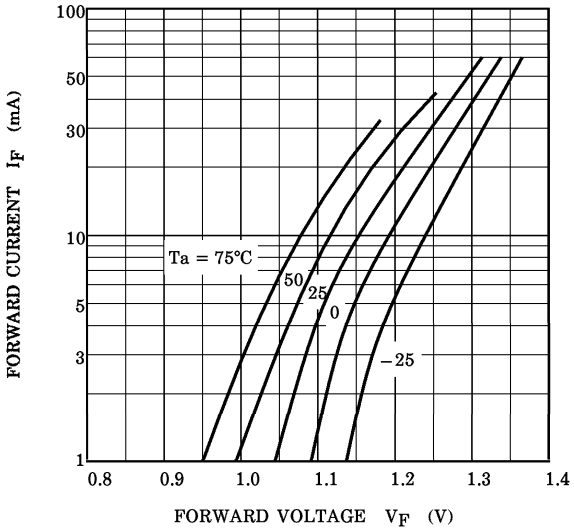
I_F – Ta



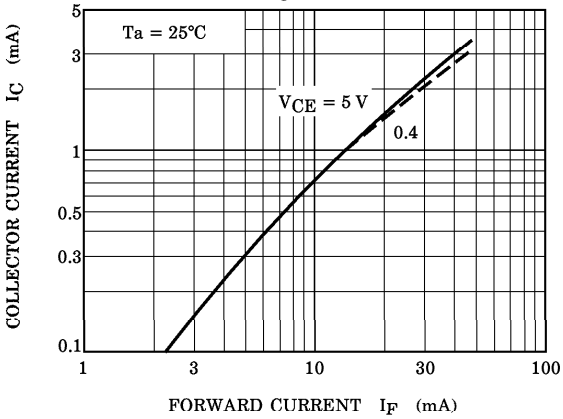
P_C – Ta



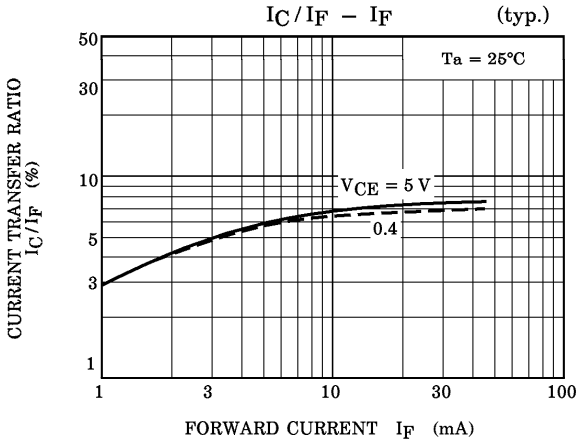
I_F – V_F (typ.)



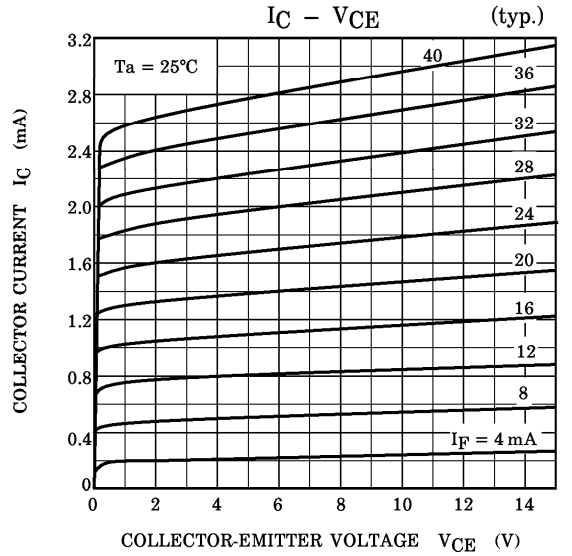
I_C – I_F



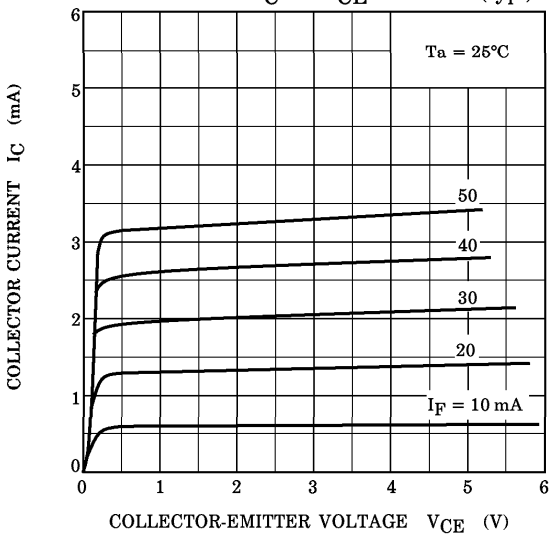
I_C / I_F – I_F (typ.)



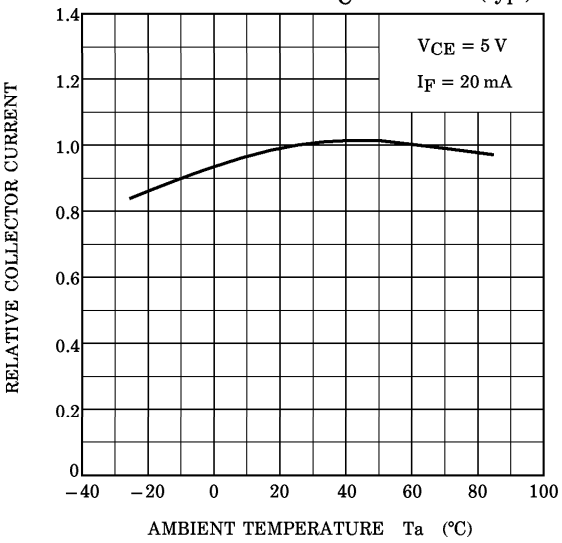
I_C – V_{CE} (typ.)



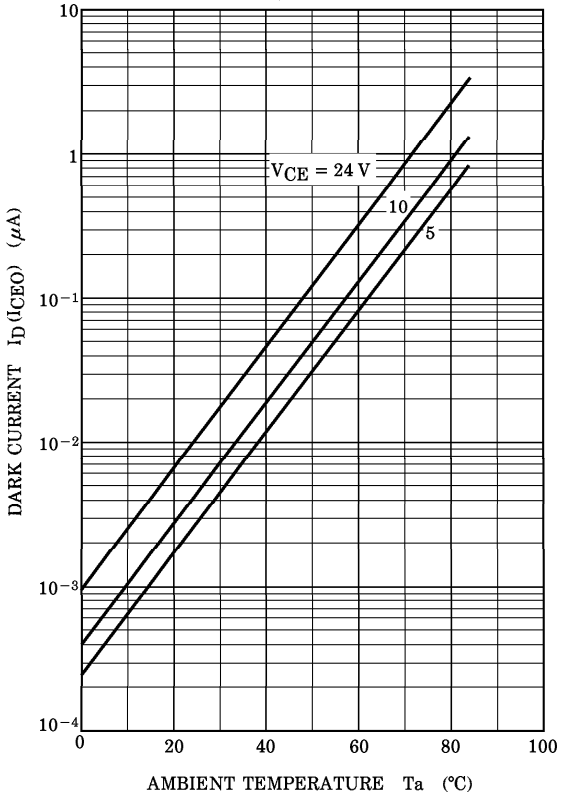
$I_C - V_{CE}$ (typ.)



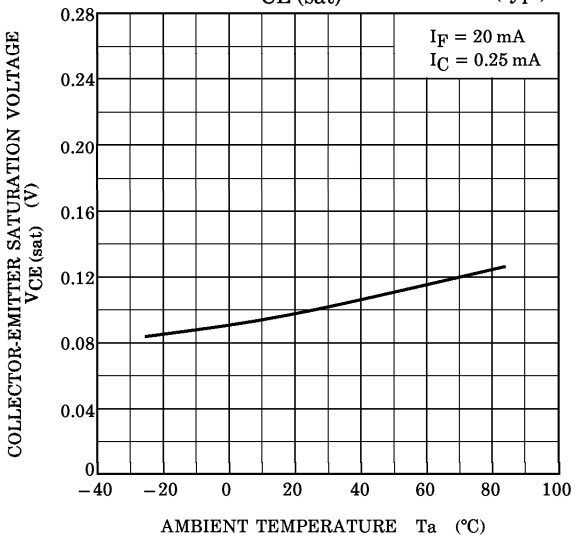
RELATIVE I_C – Ta (typ.)



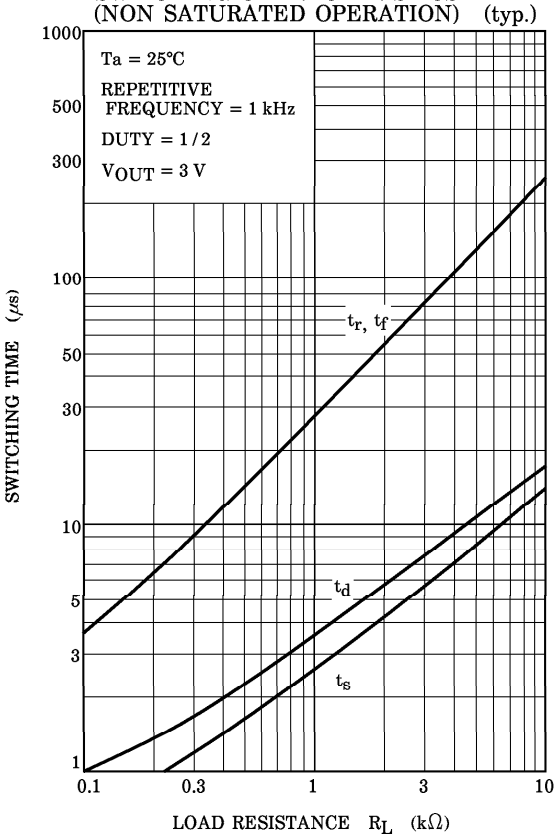
I_D (I_{CEO}) – Ta (typ.)



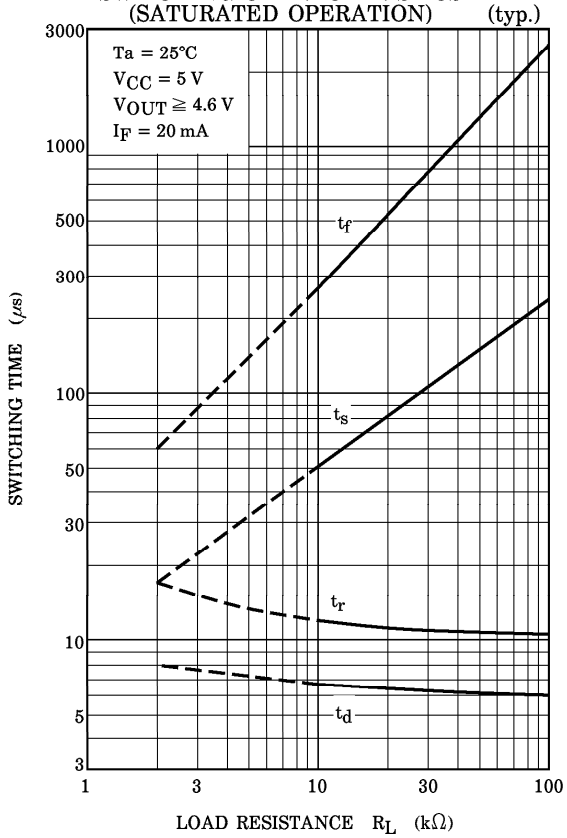
V_{CE} (sat) – Ta (typ.)



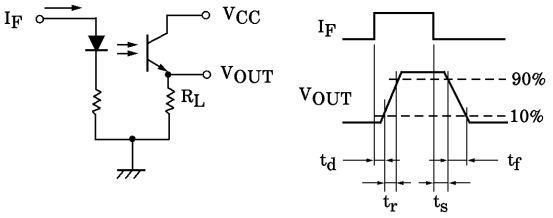
SWITCHING CHARACTERISTICS
(NON SATURATED OPERATION) (typ.)



SWITCHING CHARACTERISTICS
(SATURATED OPERATION) (typ.)

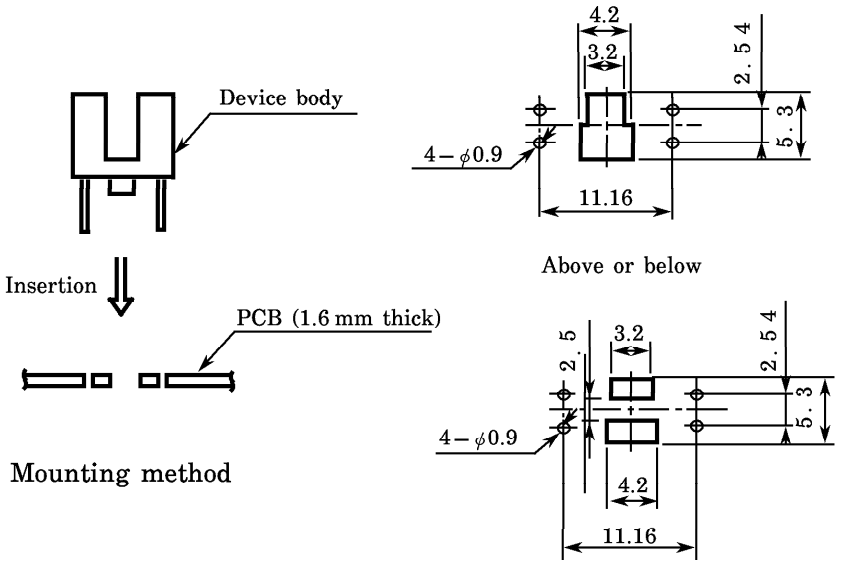


SWITCHING TIME TEST CIRCUIT



RECOMMENDED MOUNTING HOLES

Unit : mm

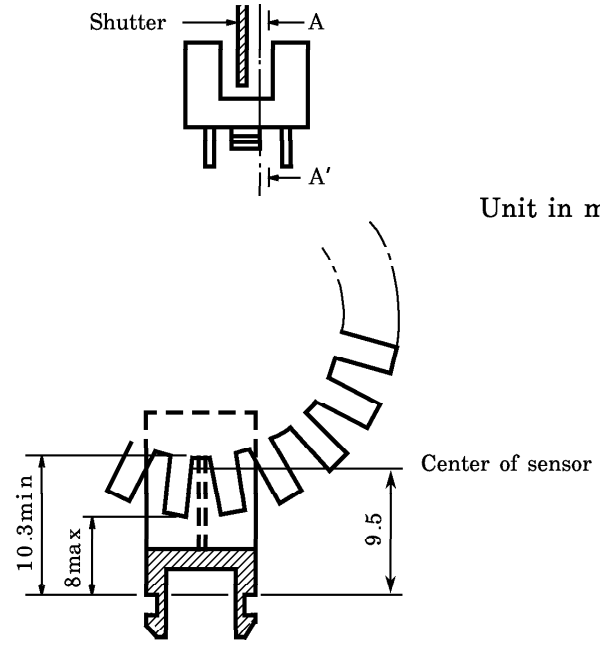


Mounting method

Recommended mounting holes

RELATIVE POSITIONING OF SHUTTER AND DEVICE

For normal operation position the shutter and the device as shown in the figure below. By considering the device's detection direction characteristic and switching time, determine the shutter slit width and pitch.



Unit in mm

Cross section between A and A′

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